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Dated: January 3, 2011
Electronic Signature for Richard J. Botos: /Richard J. Botos/

Docket No.:
ROUND 3.0-131 DIV III
(PATENT)

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Patent Application of:
Nathan R. Brown

Application No.: 10/715,267

Group Art Unit: 1716

Filed: November 17, 2003

Examiner: S. MacArthur

For: METHODS FOR POLISHING
SEMICONDUCTOR DEVICE STRUCTURES
BY DIFFERENTIALLY APPLYING
PRESSURE TO SUBSTRATES THAT
CARRY THE SEMICONDUCTOR DEVICE
STRUCTURES

MS RCE
Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

INFORMATION DISCLOSURE STATEMENT

Dear Sir:

It is respectfully requested that the references listed on the enclosed form be made of record and considered with respect to the above-referenced U.S. patent application. A copy of each reference which is not a U.S. patent or patent application is enclosed. Submission of the present Information Disclosure Statement should not be taken as an admission that the cited references are legally available prior art or that the same are pertinent or material.

Application No.: 10/715,267

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In the event that any fee is due in connection with the present Information Disclosure Statement, the Commissioner is hereby authorized to charge the same to our Deposit Account No. 12-1095.

Dated: January 3, 2011

Respectfully submitted,

Electronic signature:

/Richard J. Botos/

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